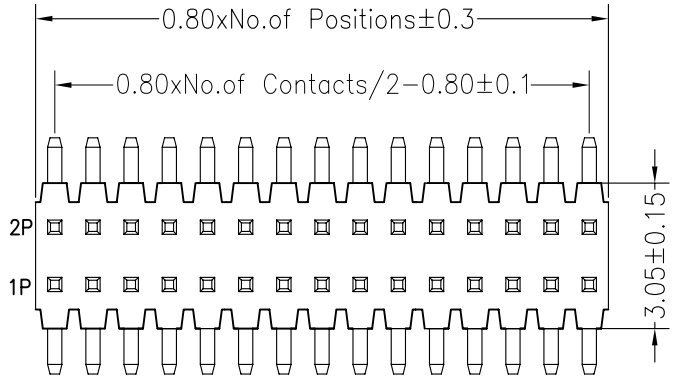
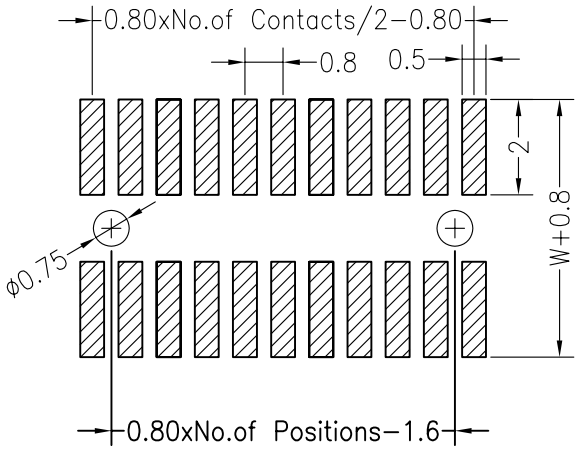
HSF RoHS FILE NO :E362810

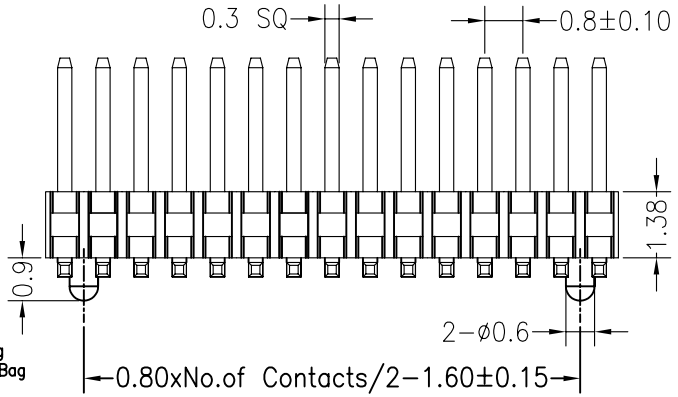
SPECIFICATIONS
Rated Current:0.75AMP
Contact Resistance:30mΩ Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

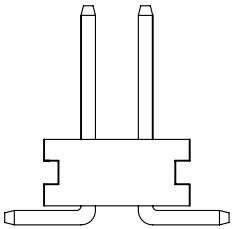
Contact Material:Brass
Contact Plating:Au Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: LCP
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)



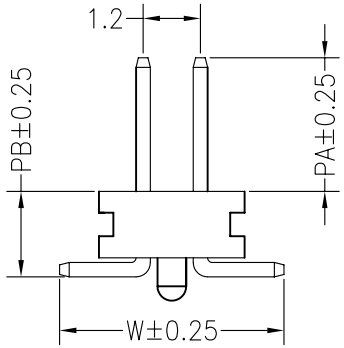
Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)







N= W/O Post



W= With Post

Ordering Information

1713 -12 XX X X XX M XXX X 01

No.of Pins Per Row	Insulator Material Option	Post	Contact Plating	Pin Length	Packing
2x50 2~100	A=BK−PBT B=BK−PA66 C=BK−PA6T D=BK−PA46 F=BK−LCP	W=With Post N=W/O Post	G0:Gold Flash G2:5U" Gold G3:10U" Gold G4:15U" Gold G5:30U" Gold S0:Gold Flash/Tin SN:Tin		0=PE Bag A=Tray T=Tube P=Tube+Cap R=Reel+Cap M=Reel+Mylar

Dimension antitheses list				
ITEM	PA	PB	W	L
Standard	2.80	1.80	4.60	6.00
Alternate				

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2012.04.18	NEW DRAWING	

OPERATION	
X.X	±0.30
X.XX	±0.20
X.XXX	±0.10
Angle	±3°
DIM	TOL

DRAW	Liu Miao	12.04.18
CHECK		
APPROVE		

SCALE	FIT
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	171312XXXXXXMXXXX01
TITLE:	0.8*1.2mm Pin Header Dual Row SMT